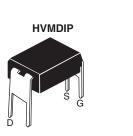
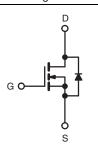


COMPLIANT

### **Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	250	250				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V	1.1				
Q <sub>g</sub> (Max.) (nC)	14	14				
Q <sub>gs</sub> (nC)	2.7	2.7				
Q <sub>gd</sub> (nC)	7.8					
Configuration	Sing	Single				





N-Channel MOSFET

### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serveres as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION				
Package	HVMDIP			
Lead (Pb)-free	IRFD224PbF			
Lead (i b)-iiee	SiHFD224-E3			

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	250	.,,	
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>A</sub> = 25 °C	,	0.63	А	
Continuous Drain Current		T <sub>A</sub> = 100 °C	ID	0.40		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	5.0		
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	60	mJ	
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	0.63	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	0.10	mJ	
Maximum Power Dissipation $T_A = 25  ^{\circ}\text{C}$		P <sub>D</sub>	1.0	W		
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.8	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	00	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 15 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 2.5 A (see fig. 12).
- c.  $I_{SD} \leq 4.4$  A,  $dI/dt \leq 90$  A/µs,  $V_{DD} \leq V_{DS},$   $T_{J} \leq 150$  °C.
- d. 1.6 mm from case.

# IRFD224, SiHFD224

# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	120	°C/W	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		-		ļ		L	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		250	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I <sub>D</sub> = 1 mA	-	0.36	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zon Oale William Burin Oamal	I <sub>DSS</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V		-	25	μΑ
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 200 V	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	250	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 0.38 A <sup>b</sup>	-	-	1.1	Ω
Forward Transconductance	9fs	V <sub>DS</sub>	= 50 V, I <sub>D</sub> = 2.6 A	1.5	-	-	S
Dynamic					•		,
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	260	-	pF
Output Capacitance	C <sub>oss</sub>	1	$V_{DS} = 25 \text{ V},$		77	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	15	-	
Total Gate Charge	Qg		I <sub>D</sub> = 4.4 A, V <sub>DS</sub> = 200 V, see fig. 6 and 13 <sup>b</sup>	-	-	14	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	-	2.7	
Gate-Drain Charge	$Q_{gd}$		see lig. 6 and 13-		-	7.8	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 125 V, $I_D$ = 4.4 A, $R_g$ = 18 $\Omega$ , $R_D$ = 28 $\Omega$ , see fig. 10 <sup>b</sup>		-	7.0	-	ns ns
Rise Time	t <sub>r</sub>			-	13	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	20	-	
Fall Time	t <sub>f</sub>			-	12	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	ъU
Internal Source Inductance	L <sub>S</sub>			-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	0.63	^
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	5.0	- A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 0.63 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	1.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05.00 :	4.4.4. W/W 400.6.4. b	-	200	400	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_{\rm J} = 25~{\rm ^{\circ}C}, I_{\rm F} = 4.4~{\rm A}, dI/dt = 100~{\rm A/\mu s^b}$		-	0.93	1.9	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				L <sub>D</sub> )	

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$





### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

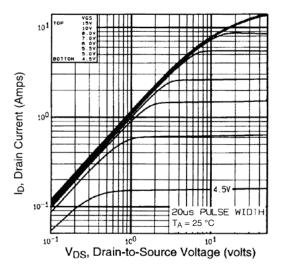


Fig. 1 - Typical Output Characteristics,  $T_A$  = 25 °C

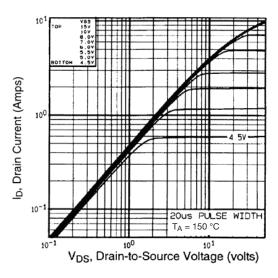


Fig. 2 - Typical Output Characteristics,  $T_A$  = 150 °C

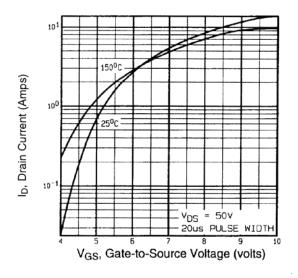


Fig. 3 - Typical Transfer Characteristics

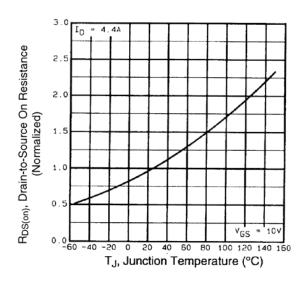


Fig. 4 - Normalized On-Resistance vs. Temperature



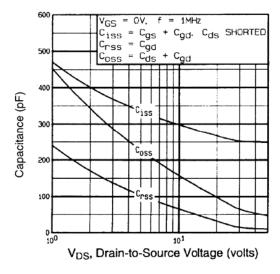


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

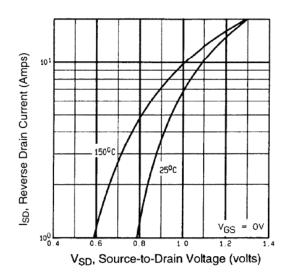


Fig. 7 - Typical Source-Drain Diode Forward Voltage

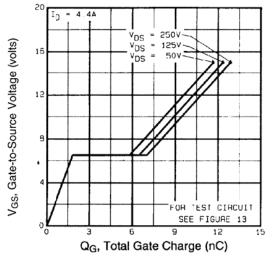


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

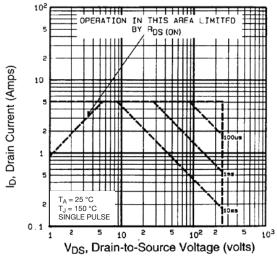


Fig. 8 - Maximum Safe Operating Area





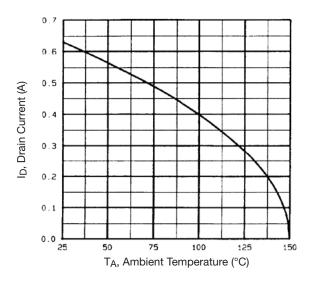


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

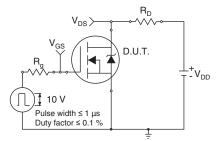


Fig. 10a - Switching Time Test Circuit



Fig. 10b - Switching Time Waveforms

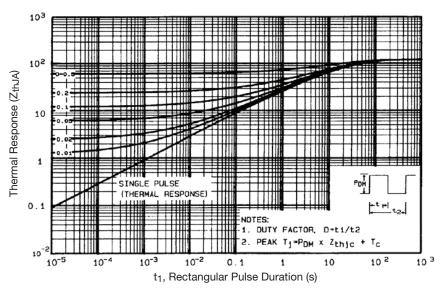


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



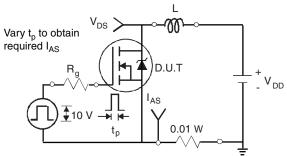


Fig. 12a - Unclamped Inductive Test Circuit

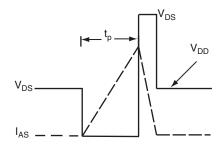


Fig. 12b - Unclamped Inductive Waveforms

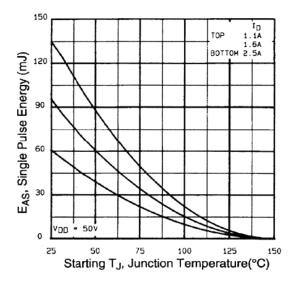


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

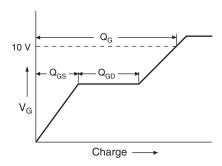


Fig. 13a - Basic Gate Charge Waveform

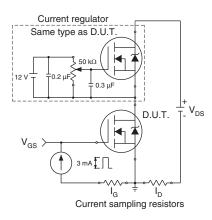
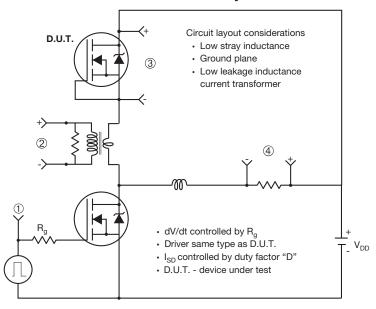


Fig. 13b - Gate Charge Test Circuit





### Peak Diode Recovery dV/dt Test Circuit



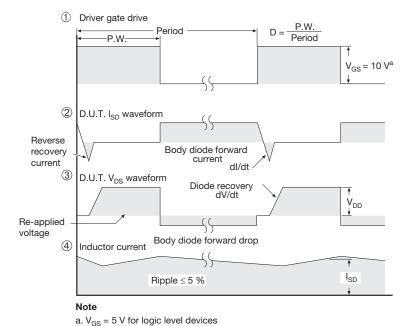
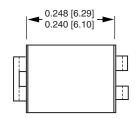
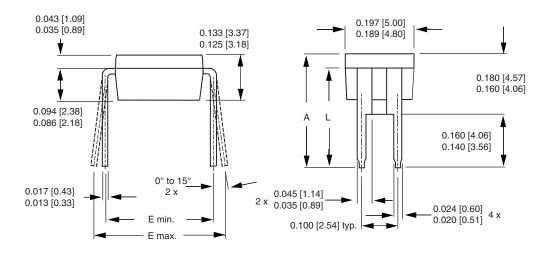


Fig. 14 - For N-Channel

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### **HVM DIP** (High voltage)





	INCHES		MILLIMETERS	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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